

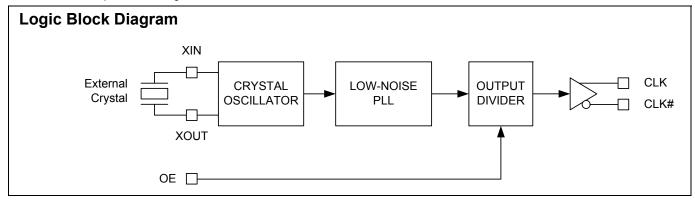
100 MHz LVDS Clock Generator

Features

- One LVDS Output Pair
- Output Frequency: 100 MHz
- External Crystal Frequency: 25 MHz
- Low RMS Phase Jitter at 100 MHz, using 25 MHz Crystal (637 kHz to 10 MHz): 0.53 ps (Typical)
- Pb-free 8-Pin TSSOP Package
- Supply Voltage: 3.3V or 2.5V
- Commercial Temperature Range

Functional Description

The CY2XL11 is a PLL (Phase Locked Loop) based high performance clock generator with a crystal oscillator interface and one LVDS output pair. It is optimized to generate PCI Express, FC, and other high performance clock frequencies. It also produces an output frequency that is four times the crystal frequency. It uses Cypress's low noise VCO technology to achieve less than 1 ps typical RMS phase jitter, that meets high performance systems' jitter requirements.



Pinouts

Figure 1. Pin Diagram - 8-Pin TSSOP

VDD 🖂	1	8	
VSS 🖂	2	7	
XOUT 🚞	3	6	CLK#
	4	5	D OE

Table 1. Pin Definition - 8-Pin TSSOP

Pin Number	Pin Name	I/О Туре	Description
1, 8	VDD	Power	3.3V or 2.5V power supply. All supply current flows through pin 1
2	VSS	Power	Ground
3, 4	XOUT, XIN	XTAL output and input	Parallel resonant crystal interface
5	OE	CMOS input	Output Enable. When HIGH, the output is enabled. When LOW, the output is high impedance
6,7	CLK#, CLK	LVDS output	Differential clock output

198 Champion Court

٠

San Jose, CA 95134-1709 • 408-943-2600 Revised June 12, 2009



Frequency Table

Input Crystal Frequency (MHz)	PLL Multiplier Value	Output Frequency (MHz)
25	4	100

Absolute Maximum Conditions

Parameter	Description	Condition	Min	Max	Unit
V _{DD}	Supply Voltage		-0.5	4.4	V
V _{IN} ^[1]	Input Voltage, DC	Relative to V _{SS}	-0.5	V _{DD} + 0.5	V
Τ _S	Temperature, Storage	Non operating	-65	150	°C
TJ	Temperature, Junction			135	°C
ESD _{HBM}	ESD Protection (Human Body Model)	JEDEC STD 22-A114-B	2000		V
UL-94	Flammability Rating	At 1/8 in.	V-0		
Θ _{JA} [2]	Thermal Resistance, Junction to	0 m/s airflow	100		°C/W
	Ambient	1 m/s airflow	91		
		2.5 m/s airflow	8	37	

Operating Conditions

Parameter	Description	Min	Max	Unit
V _{DD}	3.3V Supply Voltage	3.135	3.465	V
	2.5V Supply Voltage	2.375	2.625	V
T _A	Ambient Temperature	-5	70	°C
	Power up time for all V_{DD} to reach minimum specified voltage (ensure power ramps is monotonic)	0.05	500	ms

DC Electrical Characteristics

Parameter	Description	Test Conditions	Min	Тур	Max	Unit
I _{DD} ^[4]	Power Supply Current with output terminated	V_{DD} = 3.465V, OE = V_{DD} , output terminated	-	-	120	mA
		V_{DD} = 2.625V, OE = V_{DD} , output terminated	-	-	115	mA
V _{OD} ^[6]	LVDS Differential Output Voltage	V_{DD} = 3.3V or 2.5V, R_{TERM} = 100 Ω between CLK and CLK#	250	-	450	mV
$\Delta V_{OD}^{[6]}$	Change in V _{OD} between Comple- mentary Output States	V_{DD} = 3.3V or 2.5V, R_{TERM} = 100 Ω between CLK and CLK#	-	-	50	mV
V _{OS} ^[7]	LVDS Offset Output Voltage	V_{DD} = 3.3V or 2.5V, R_{TERM} = 100 Ω between CLK and CLK#	1.125	-	1.375	V
ΔV _{OS}	Change in V _{OS} between Comple- mentary Output States	V_{DD} = 3.3V or 2.5V, R_{TERM} = 100 Ω between CLK and CLK#	_	_	50	mV
I _{OZ}	Output Leakage Current	Three-state output, PD#/OE = V _{SS}	-35	_	35	μA

Notes

 The voltage on any input or IO pin cannot exceed the power pin during power up.
Simulated using Apache Sentinel TI software. The board is derived from the JEDEC multilayer standard. It measures 76 x 114 x 1.6 mm and has 4-layers of copper (2/1/1/2 oz.). The internal layers are 100% copper planes, while the top and bottom layers have 50% metalization. No vias are included in the model. 3. Outputs are terminated with 100Ω between CLK and CLK#. Refer to Figure 8 on page 5.

I_{DD} includes ~4 mA of current that is dissipated externally in the output termination resistor.
Not 100% tested, guaranteed by design and characterization.

6. Refer to Figure 2 on page 4.

7. Refer to Figure 3 on page 4.



DC Electrical Characteristics (continued)

Parameter	Description	Test Conditions	Min	Тур	Max	Unit
V _{IH}	Input High Voltage, OE pin		0.7*V _{DD}	_	-	V
V _{IL}	Input Low Voltage, OE pin		-	_	0.3*V _{DD}	V
I _{IH}	Input High Current, OE pin	OE = V _{DD}	-	_	115	μA
IIL	Input Low Current, OE pin	OE = V _{SS}	-50	_	-	μA
C _{IN}	Input Capacitance, OE pin			15		pF
C _{INX}	Pin Capacitance, XIN & XOUT			4.5		pF

AC Electrical Characteristics^[3]

Parameter	Description		Min	Тур	Max	Unit
F _{OUT}	Output Frequency		-	100	-	MHz
T _R , T _F ^[8]	Output Rise or Fall time	20% to 80% of full output swing	-	500	-	ps
$T_{Jitter(\phi)}^{[11]}$	RMS Phase Jitter (Random)	F _{UT} =100 MHz, (637 kHz–10 MHz)	-	0.53	-	ps
T _{DC} ^[9]	Duty Cycle	Measured at zero crossing point	45	-	55	%
T _{OHZ} ^[10]	Output Disable Time	Time from falling edge on OE to stopped outputs (Asynchronous)	-	-	100	ns
T _{OE} ^[10]	Output Enable Time	Time from rising edge on OE to outputs at a valid frequency (Asynchronous)	-	-	100	ns
Т _{LOCK}	Startup Time	Time for CLK to reach valid frequency measured from the time $V_{DD} = V_{DD}(min.)$	-	-	10	ms

Crystal Characteristics

Parameter	Description	Min	Max	Unit
	Mode of Oscillation	Fundamental		
F	Frequency	25	25	MHz
ESR	Equivalent Series Resistance	-	50	Ω
C _S	Shunt Capacitance	-	7	pF

Notes

8. Refer to Figure 4 on page 4.
9. Refer to Figure 5 on page 4.
10. Refer to Figure 6 on page 4.
11. Refer to Figure 7 on page 5.



Switching Waveforms

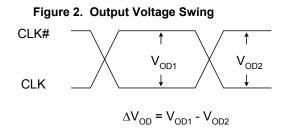
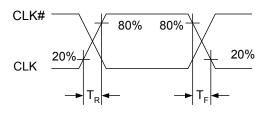


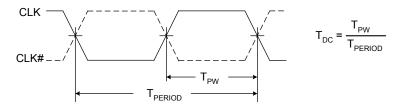
Figure 3. Output Offset Voltage

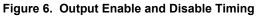


Figure 4. Output Rise or Fall Time









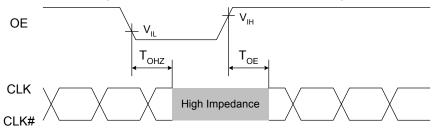
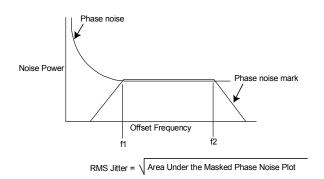


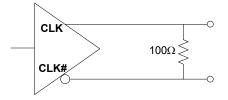


Figure 7. RMS Phase Jitter



Termination Circuits



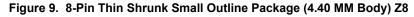


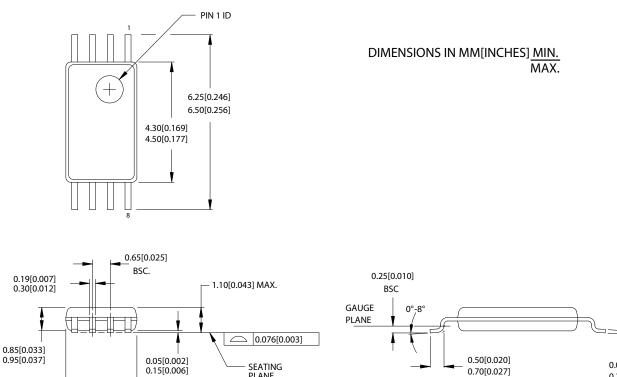


Ordering Information

Part Number	Package Description	Product Flow
CY2XL11ZXC	8-pin TSSOP	Commercial, –5°C to 70°C
CY2XL11ZXCT	8-pin TSSOP - Tape and Reel	Commercial, –5°C to 70°C

Package Drawing and Dimensions





SEATING PLANE

51-85093-*A

0.70[0.027]

0.09[[0.003]

0.20[0.008]

2.90[0.114] 3.10[0.122]



Document History Page

	Document Title: CY2XL11 100 MHz LVDS Clock Generator Document Number: 001- 42886					
REV.	ECN NO.	Submission Date	Orig. of Change	Description of Change		
**	2117527	See ECN	WWZ/KVM /AESA	New data sheet		
*A	2669117	03/05/2009	KVM/ AESA	Changed crystal and output frequency Removed MSL spec Changed IIL value from -20 uA to -50 uA Changed IIH value from 20 uA to 115 uA Changed phase jitter value from 1 to 0.53 ps Changed junction temp from 125°C to 135°C Changed IDD from 150 mA to 120 mA Rise / fall time changed to 350 ps to 500ps Changed Data Sheet Status to Final		
*В	2700242	04/30/2009	KVM/ PYRS	Typo correction Reformatted AC and DC tables Added IDD spec for 2.5V Added CINX and TLOCK specs Changed CIN from 7pF to 15pF		
*C	2718433	06/12/2009	WWZ/HMT	No change. Submit to ECN for product launch.		

Sales, Solutions, and Legal Information

Worldwide Sales and Design Support

Cypress maintains a worldwide network of offices, solution centers, manufacturer's representatives, and distributors. To find the office closest to you, visit us at cypress.com/sales.

Products		PSoC Solutions	
PSoC	psoc.cypress.com	General	psoc.cypress.com/solutions
Clocks & Buffers	clocks.cypress.com	Low Power/Low Voltage	psoc.cypress.com/low-power
Wireless	wireless.cypress.com	Precision Analog	psoc.cypress.com/precision-analog
Memories	memory.cypress.com	LCD Drive	psoc.cypress.com/lcd-drive
Image Sensors	image.cypress.com	CAN 2.0b	psoc.cypress.com/can
		USB	psoc.cypress.com/usb

© Cypress Semiconductor Corporation, 2007-2009. The information contained herein is subject to change without notice. Cypress Semiconductor Corporation assumes no responsibility for the use of any circuitry other than circuitry embodied in a Cypress product. Nor does it convey or imply any license under patent or other rights. Cypress products are not warranted nor intended to be used for medical, life support, life saving, critical control or safety applications, unless pursuant to an express written agreement with Cypress. Furthermore, Cypress does not authorize its products for use as critical components in life-support systems where a malfunction or failure may reasonably be expected to result in significant injury to the user. The inclusion of Cypress products in life-support systems and in doing so indemnifies Cypress against all charges.

Any Source Code (software and/or firmware) is owned by Cypress Semiconductor Corporation (Cypress) and is protected by and subject to worldwide patent protection (United States and foreign), United States copyright laws and international treaty provisions. Cypress hereby grants to licensee a personal, non-exclusive, non-transferable license to copy, use, modify, create derivative works of, and compile the Cypress Source Code and derivative works for the sole purpose of creating custom software and or firmware in support of licensee product to be used only in conjunction with a Cypress integrated circuit as specified in the applicable agreement. Any reproduction, modification, translation, compilation, or representation of this Source Code except as specified above is prohibited without the express written permission of Cypress.

Disclaimer: CYPRESS MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARD TO THIS MATERIAL, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE. Cypress reserves the right to make changes without further notice to the materials described herein. Cypress does not assume any liability arising out of the application or use of any product or circuit described herein. Cypress does not authorize its products for use as critical components in life-support systems where a malfunction or failure may reasonably be expected to result in significant injury to the user. The inclusion of Cypress' product in a life-support systems application implies that the manufacturer assumes all risk of such use and in doing so indemnifies Cypress against all charges.

Use may be limited by and subject to the applicable Cypress software license agreement.

Document Number: 001-42886 Rev. *C

All products and company names mentioned in this document may be the trademarks of their respective holders.